



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

July 28, 2010

Applicants: Toshihiro TAI et al
For: PLATED RESIN MOLDED ARTICLES
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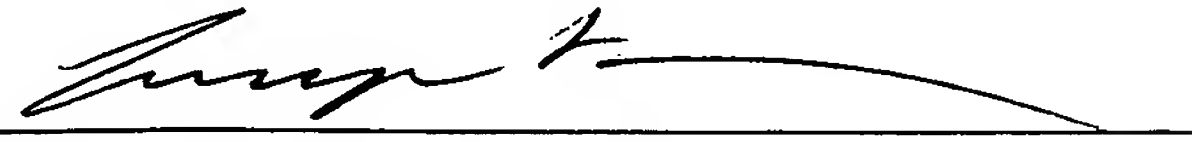
LETTER TO EXAMINER

Sir:

This Request for Continued Examination (RCE) is being filed in order to have the Amendment After Final Rejection dated June 25, 2010 entered into the record of the present application. As stated in the previous Response, the instant invention provides a plated resin molded article which exhibits a high adhesion strength between a thermoplastic resin molded article and a metal plating layer and also imparts a beautiful aesthetic appearance to the plated resin molded article. The articles prepared by the present invention are provided by a treatment that does not need the use of a heavy metal-containing acid and therefore avoids problems with respect to environmental hazards that occur through the use of a heavy metal etching treatment. The five components used in providing the thermoplastic resin molded article of the present invention have a synergistic effect in giving an improved adherence strength to a metal plating

layer. The prior art cited by the Examiner does not disclose the presently claimed invention. Favorable consideration is respectfully solicited.

Respectfully submitted,



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Encl: None

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